

MIN Faculty Department of Informatics



# Topology-Aware Routing of Electric Wires in FDM-Printed Objects

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- 1. Introduction
- 2. Motivation
- 3. 2D-Routing
- 4. Inter-Layer connections
- 5. Wire collisions

## **Mission Statement**

Introduction		

Full integration of electronic components and circuits into plastic objects in a single additive manufacturing process.

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Full integration of electronic components and circuits into plastic objects in a single additive manufacturing process.

+ Keep it low-cost!

Introduction

Motivation

2D-Routing

Inter-Layer connections

Wire collisions

#### Slight modifications...



Introduction

Motivation

2D-Routing

Inter-Layer connections

# .

#### Conductive ink extruder



Introduction

Motivation

2D-Routing

Inter-Laver connections

#### Cameras





Introduction

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Inter-Layer connections

Wire collisions

#### Vacuum gripper





# Software tool-chain



# Software tool-chain



# Software tool-chain



# Video

Introduction

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Wire collisions



- Align with object geometry
- Changing process parameters (extrusion width, perimeters, ...)
- Align with wires
- Interlayer connections



## Align with object geometry

- Changing process parameters (extrusion width, perimeters, ...)
- Align with wires

#### Interlayer connections







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# VLSI- / PCB-Routing??

	2D-Routing	

VLSI- / PCB-Routing??

Motivation

Introduction

VLSI / PCB	3D-printed
Many components	Few components
Many connections	Few connections
Few layers	Many layers
High resolution	Low resolution
Simple geometries (PCB)	complex geometries (mesh)
"Process for circuit"	"Circuit for process"
Direct Z-Interconnects	?

2D-Routing

# Result for a single wire





 Assemble routing-graph

2D-Routing

- Existing contours
- Direct rubberband connections
- Infill-Grid
- ► A\* routing





2D-Routing

Inter-Layer co

Wire collisions

#### Assemble routing-graph

- Existing contours
- Direct rubberband connections
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Assemble routing-graph
Existing contours

2D-Routing

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- Assemble routing-graph
- Existing contours
- Direct rubberband connections
- Infill-Grid
- ► A\* routing





# Inter-Layer connections



- Direct linear connections
- Dynamically exploring connections

# Inter-Layer connections

Inter-Layer connections

Wire collisions

- Direct linear connections
- Dynamically exploring connections

















# Dynamically exploring connections



# Dynamically exploring connections



# **Overlapping wire segments**

























Introduction Motivation 2D-Routing Inter-Layer connections Wire collis $7 = 3 4$	tion 2D-Routing Inter-Layer connections Wire collisions
7 = 3 A	

# Result

Introduction Motivation 2D-Routing Inter-Layer connections Wire collisions

# Wire collisions



# Wire collisions





ntroduction

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#### Download / Sourcecode:

#### tams.informatik.uni-hamburg.de/research/3d-printing/conductive\_printing

github.com/platsch/Slic3r